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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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Ji Zhu

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EXAMINER

OLSEN, ALLAN W

ART UNIT

PAPER NUMBER

1716

MAIL DATE

DELIVERY MODE

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PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Office Action Summary	Application No. 10/599,106	Applicant(s) ZHU ET AL.	
	Examiner Allan Olsen	Art Unit 1716	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 14 October 2010.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-135 is/are pending in the application.
- 4a) Of the above claim(s) 34-135 is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-33 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☒ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413) |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | Paper No(s)/Mail Date. _____ |
| 3) <input checked="" type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08) | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Election/Restrictions

Applicant's election of Group I, claims 1-33 in the reply filed on October 14, 2010 is acknowledged. Because applicant did not distinctly and specifically point out the supposed errors in the restriction requirement, the election has been treated as an election without traverse (MPEP § 818.03(a)). Claims 34-135 are withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected inventions, there being no allowable generic or linking claim.

Claim Objections

Claim 30 is objected to under 37 CFR 1.75(c), as being of improper dependent form for failing to further limit the subject matter of a previous claim. Applicant is required to cancel the claim, or amend the claim to place the claim in proper dependent form, or rewrite the claim in independent form. Claim 1 recites "...thereby creating at least one nanostructure in the top layer". Claim 30, which is dependent upon claim 1, recites and "...the nanostructure comprises the top layer of the substrate"

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

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(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1, 10-14, 17, 22-24 and 30 are rejected under 35 U.S.C. 102(b) as being anticipated by US Patent 6,110,837 issued to Linliu et al. (hereinafter, Linliu).

Regarding claim 1, Linliu teaches a method of fabricating a nanostructure array comprising: providing a substrate (figure 1, 100) having a top layer (figure 1, 120 or 130), and depositing a sacrificial layer having a first etching characteristic, patterning the sacrificial layer (figure 1, 200), forming a thin conformal layer (figure 2, 210) having a second etching characteristic over the patterned sacrificial structure, wherein the first and second etching characteristics are different, anisotropically etching the conformal layer to create a pattern (figure 3), removing the sacrificial layer (figure 4), transferring the resulting conformal layer structure to the substrate by etching, and removing any remaining conformal layer structure, thereby creating at least one nanostructure in the top layer (figure 7).

Regarding claim 10, Linliu teaches the substrate is a multilayer structure, comprising: a lower layer (100) comprising silicon, an intermediate layer (110) comprising an insulating material, an upper layer (120) comprising a semiconductor (see column 4, lines 12-18).

Regarding claim 11, Linliu teaches the intermediate insulating material is an oxide (see column 4, lines 12-18).

Regarding claim 12, Linliu teaches the upper semiconductor is polysilicon (see column 4, lines 12-18).

Regarding claim 13, Linliu teaches providing a protective layer (figures 1-8, 130 when layer 120 corresponds to the claimed layer) below the sacrificial layer.

Regarding claim 14, Linliu teaches the sacrificial layer is patterned by photolithography (column 4, lines 24-26).

Regarding claim 17, Linliu teaches the sacrificial layer is removed by wet etching (column 4, lines 62-63).

Regarding claims 22 and 23, Linliu teaches the substrate and the top layer comprise the same material (Si) and are separated by an insulator layer (see column 4, lines 12-18).

Regarding claim 24, by virtue of the photolithography process, Linliu teaches at least one nanostructure is fabricated on a predetermined location with positional control.

Regarding claim 30, Linliu teaches the nanostructure comprises the top layer of the substrate (figure 8).

Claims 1-4 and 6-33 are rejected under 35 U.S.C. 102(e) as being anticipated by US Patent Application Publication 2004/0136866 as filed by Pontis et al. (hereinafter, Pontis).

Regarding claim 1, Pontis teaches a method of fabricating a nanostructure array comprising: providing a substrate (figure 6A, 606) having a top layer (figure 6B, 608 or figure 6A, 602), and depositing a sacrificial layer having a first etching characteristic, patterning the sacrificial layer (figure 6E, 610), forming a thin conformal layer (figure 6F, 616) having a second etching characteristic over the patterned sacrificial structure, wherein the first and second etching characteristics are different, anisotropically etching the conformal layer to create a pattern (figure 6G, 618, 620), removing the sacrificial layer (figure 6H), transferring the resulting conformal layer structure to the substrate by etching, and removing any remaining conformal layer structure, thereby creating at least one nanostructure in the top layer (figure 6J).

Regarding claims 2-4 and 6-9, Pontis teaches reducing the dimension of the nanostructure by thermal oxidation of Si nanowires and contacting with an etchant to remove the oxide ([0061]).

Regarding claims 10-12, Pontis teaches the substrate is a multilayer structure, comprising: a lower layer (606) comprising silicon, an intermediate layer (604) comprising an insulating material, such as an oxide, an upper layer (602) comprising a semiconductor, such as silicon (see [0073]).

Regarding claim 13, Pontis teaches providing a protective layer (608) below the sacrificial layer.

Regarding claim 14, Pontis teaches the sacrificial layer is patterned by photolithography ([0073]).

Regarding claim 15, Pontis teaches the conformal layer comprises silicon oxide ([0074]).

Regarding claim 16, Pontis teaches the conformal layer can be formed by chemical vapor deposition, spin coating, sputtering, evaporation or chemical reaction with the sacrificial layer ([0074]).

Regarding claim 17, Pontis teaches the sacrificial layer is removed by wet etching ([0077]).

Regarding claims 18-21, Pontis teaches forming a contact in intimate contact with at least one nanostructure wherein the contact is formed by forming a conducting film, photolithographically masking the contact area, and etching any exposed film away ([0080] - [0086], [0107]).

Regarding claims 22 and 23, Pontis teaches the substrate and the top layer comprise the same material (Si) and are separated by an insulator layer ([0073]).

Regarding claim 24, by virtue of the photolithography process, Pontis teaches at least one nanostructure is fabricated on a predetermined location with positional control ([0050]).

Regarding claim 25, Pontis teaches there are between 1000 and 1 billion nanostructures on the array, which are fabricated on a predetermined location and with positional control ([0114]).

Regarding claims 26-29, Pontis teaches functionalizing different nanostructures with different functionalizing including agents such as one or more receptors selected from the group consisting of ss-DNAs, proteins, antibodies, platinum, photoactive

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molecules, photonic nanoparticle, inorganic ion, inorganic nanoparticle, magnetic ion, magnetic nanoparticle, electronic nanoparticle, metallic nanoparticle, metal oxide nanoparticle, gold nanoparticle, gold-coated nanoparticle, carbon nanotube, nanocrystal, quantum dot, protein domain, enzyme, hapten, antigen, biotin, digoxigenin, lectin, toxin, radioactive label, fluorophore, chromophore, or a chemiluminescent molecule ([0108] – [0111]).

Regarding claim 30, Pontis teaches the nanostructure comprises the top layer of the substrate (figure 6K).

Regarding claim 31, Pontis teaches at least one contact positioned on a top layer of the substrate, and the contact, the nanostructure and the top layer comprise the same material ([0086] with the sacrificial silicon layer corresponding to the claimed contact)

Regarding claim 32, Pontis teaches at least one contact is positioned in intimate contact with more than one nanostructure ([0113], multiplexing circuitry).

Regarding claim 33, Pontis teaches the nanostructure comprises a material selected from the group consisting of SnO₂, TiO₂, Fe oxides, ZnO, WO₃, Ga₂O₃ and perovskites ([0099]).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the

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invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

Claim 5 is rejected under 35 U.S.C. 103(a) as being unpatentable over Pontis as applied above to claim 3.

Pontis does not teach using a controlled XeF_2 etch to the reduction a dimension of the nanostructure.

The examiner takes Official Notice that the use of XeF_2 etch Si is well known and that it would be obvious to etch the Si with XeF_2 because this etching method is particularly noted for being an extremely clean process that is very controllable.

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to Allan Olsen whose telephone number is 571-272-1441. The examiner can normally be reached on M, W and F: 1-5.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Parviz Hassanzadeh can be reached on 571-272-1435. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Allan Olsen/
Primary Examiner, Art Unit 1716